507353646 06/24/2022

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:		NEW ASSIGNMENT				
IATURE OF CONVEYAN	NCE:	ASSIGNMENT	ASSIGNMENT			
CONVEYING PARTY D	ΑΤΑ					
		Name			Execution Date	
BHUPENDRA KUMAR S	SONI				07/03/2018	
BROOKS JOHN KELLY					07/09/2018	
JAMES PATRICK LANG	AN				07/03/2018	
HUNTINGTON DAVIS					07/07/2018	
ALAN D HAHN					07/10/2018	
RECEIVING PARTY DA	ТА					
Name: MYCOTECHNOLOGY, INC.						
Street Address:	18250	18250 E. 40TH, SUITE 50				
City:	AURORA					
State/Country:	COLORADO					
Postal Code:	80011	80011				
	Total: 1	1 Number				
Property Type		17725344				
Application Number:		17720344				
CORRESPONDENCE D	ΑΤΑ					
		(312)616-5700)616-5700			
		o the e-mail address first; if that				
•	provide	d; if that is unsuccessful, it will b	be sen	t via US N	lail.	
,		(720) 795-7976	/95-7976 vino@leydig.com, assignments@leydig.com			
Correspondent Name:		MICHAEL J. CURTIS				
Address Line 1:			PEARL EAST CIRCLE, SUITE 200			
Address Line 4: BOULDER, COLORADO 80301						
ATTORNEY DOCKET NU	JMBER:	339160: 0640.22US-5				
NAME OF SUBMITTER:		MICHAEL J. CURTIS				
SIGNATURE:		/michaelcurtisREG54053/	/ /michaelcurtisREG54053/			
DATE SIGNED:		06/24/2022	06/24/2022			
Total Attachments: 4		I				
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ASSIGNMENT

WHEREAS, IME

- Assignor: Bhupendra Kumar SONI, residing at 4255 Kittredge Street, Apt. 216, Denver, CO 80239 USA;
- Assignor: Brooks John KELLY, residing at 13243 Lackland Drive, Denver, CO 80239 USA;
- Assignor: James Patrick LANGAN, residing at 1955 Ulster Street, Unit 410, Denver, CO 80220;
- Assignor: Huntington DAVIS, residing at 401 Interlocken Drive, #6302, Broomfield, CO 80021;
- 5. Assignor: Alan D. HAHN, residing at 25 Tigerlily Drive, Lake Forest, CA 92630;

herein called individually an "ASSIGNOR" and collectively "ASSIGNORS," in connection with the invention entitled:

"Methods for the Production and Use of

Myceliated High Protein Food Compositions*;

for which the following patent application(s):

Country Code	Application Serial No.	Filing Date
US	16/025,365	July 2, 2018

was/were submitted or filed (collectively, the "LISTED APPLICATION(S)");

AND WHEREAS, Assignee: MycoTechnology, Inc.

(herein called "ASSIGNEE"), an entity organized and existing under the laws of the State of Delaware scataged to a principal place of business at: TPL 11/28/18

3155 N. Chambers Rd., Suite E Aurora, CO 80011,

HLP 11/28/18 TSK 12-7-18

D-12/21/2019

is desirous of obtaining my/our entire right, title and interest in, to and under the said invention and the said LISTED APPLICATION(S);

NOW, THEREFORE, in consideration of my contractual and other legal obligations, and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, a said ASSIGNOR, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives and assigns, my entire right, tille and interest in, to and under the invention(s) and discoveries disclosed in the LISTED APPLICATION(S), and the LISTED APPLICATION(S) and all divisions, renewals, continuations and subsequent applications thereof, and all Patents of the United States which may be granted thereon and all reissues, reexaminations, and extensions thereof, and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may

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hereafter be filed for said invention(s) and discoveries in any country or countries foreign to the United States: together with the right to file such applications and the right to claim for the same the benefit of priority of said inventions, discoveries, and patent applications listed herein, including the LISTED APPLICATION(S) and applications thereof and therefrom under The International Union for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application and applications thereof and therefrom is/are filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention(s) in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and any and all claims, causes of action, and damages for past, present, and future infringement or other unauthorized use of the above items, along with the right to sue for and to collect damages and other relief;

AND I HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND I HEREBY covenant and agree that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith;

AND I HEREBY authorize the above-mentioned ASSIGNEE or its legal representative to insert in this instrument the filing date and serial number of said application(s) or any other information that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document;

AND I HEREBY further covenant and agree that I will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to me respecting said invention(s) and discoveries, and testify in any legal proceeding, sign all lawful papers, execute all continuing and subsequent applications, including divisional, reissue and foreign applications, make all rightful oaths, and generally cooperate and do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain, maintain, and enforce proper protection for said invention(s) and discoveries in any and all countries;

AND I HEREBY further agree that this Assignment does not create any agency, employment, or partnership relationship between the parties;

AND I HEREBY further agree that this Assignment shall not be construed against any party on the ground that such party was responsible for the preparation of this Assignment, or on any related ground;

AND I HEREBY further agree that should any provision of this Assignment be determined to be void, unenforceable, or against public policy, such provision may altered in time or scope in order to give effect to such provision. If such alternation is not possible, such provision shall be deemed severed from this Assignment and the balance of this Assignment shall remain in full force and effect, so long as the original intent of this Assignment remains substantially intact.

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IN TESTIMONY WHEREOF, I hereunto set my hand and seal (if applicable) the day and year set opposite my signature.

Assignor 1: J. 14 3, 2018 (sign)

SAM

Bhupendra Kumar SON

Date

<u>Assignor 2:</u>

7.9.18 Date

(sign) Biboks

Assignor 3:

Oste

(sign) ck LANGAN

Assignor 4:

12018 Date

(sign)

Huntington DAVIS

Assignor 5:

10 2018

(sign)

Date

Alan D. HAHN

Additional Assignors on additional sheets: No

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PATENT REEL: 060308 FRAME: 0134

LVM Docket No. 330780: 0640.22US-2 Assignment

Assignee: MycoTechnology, Inc.

7/16/2015

Date

Ŵ 2 (sign) Haha (print full name) ______A

(title) <u>250</u>

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RECORDED: 06/24/2022